Electronic Pat	ent Appl	ication Fe	Transmit	tal				
Application Number:	1052	10524525						
Filing Date:	18-A	18-Aug-2005						
Title of Invention:		Method for selectively removing material from the surface of a substrate, masking material for a wafer, and wafer with masking material						
First Named Inventor/Applicant Name:	Marti	Martin Hausner						
Filer:	David	David H. Brinkman/Rhonda Etienne						
Attorney Docket Number:	BEET	BEET-09						
Filed as Large Entity								
U.S. National Stage under 35 USC 371 F	iling Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Claims in excess of 20		1615	5	52	260			
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension of Times								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Extension - 3 months with \$0 paid	1253	1	1110	1110	
Miscellaneous:					
Request for continued examination	1801	1	810	810	
	Tot	Total in USD (\$)			